



N-Channel Enhancement Mode Field Effect Transistor

Product Summary

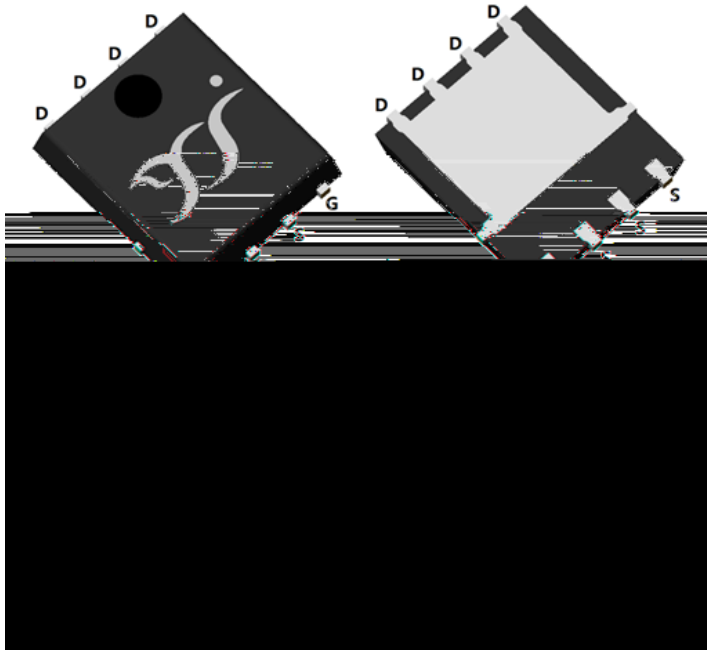
| | |
|-----------------------------------|------|
| V_{DS} | 60V |
| I_D | 85A |
| $R_{DS(ON)}$ (at $V_{GS}=10V$) | 5.2m |
| $R_{DS(ON)}$ (at $V_{GS}=4.5V$) | 8m |
| 100% EAS Tested | |
| 100% V_{DS} Tested | |

General Description

Split gate trench MOSFET technology
 Excellent package for heat dissipation
 High density cell design for low $R_{DS(ON)}$
 Moisture Sensitivity Level 1
 Epoxy Meets UL 94 V-0 Flammability Rating
 Halogen Free

Applications

Power switching application
 Uninterruptible power supply
 DC-DC convertor



Absolute Maximum Ratings ($T_A=25$ unless otherwise noted)

| Parameter | | Symbol | Limit | Unit |
|--|-------------------------|----------------|----------|------------------|
| Drain-source Voltage | | V_{DS} | 60 | V |
| Gate-source Voltage | | V_{GS} | ± 20 | V |
| Drain Current | $T_A=25^\circ\text{C}$ | I_D | 15 | A |
| | $T_A=100^\circ\text{C}$ | | 10 | |
| | $T_C=25^\circ\text{C}$ | | 85 | |
| | $T_C=100^\circ\text{C}$ | | 60 | |
| Pulsed Drain Current ^A | | I_{DM} | 340 | A |
| Avalanche energy ^B | | EAS | 144 | mJ |
| Total Power Dissipation ^C | $T_A=25^\circ\text{C}$ | P_D | 3 | W |
| | $T_A=100^\circ\text{C}$ | | 1.5 | |
| | $T_C=25^\circ\text{C}$ | | 115 | |
| | $T_C=100^\circ\text{C}$ | | 57 | |
| Junction and Storage Temperature Range | | T_J, T_{STG} | -55 +175 | $^\circ\text{C}$ |

Thermal resistance

| Parameter | | Symbol | Typ | Max | Units |
|---|--------------|----------|-----|-----|--------------------|
| Thermal Resistance Junction-to-Ambient ^D | Steady-State | R_{JA} | 40 | 50 | $^\circ\text{C/W}$ |
| Thermal Resistance Junction-to-Case | Steady-State | R_{JC} | 1.1 | 1.3 | |

Ordering Information (Example)

| PREFERRED P/N | PACKING CODE | Marking | MINIMUM PACKAGE(pcs) | INNER BOX QUANTITY(pcs) | OUTER CARTON QUANTITY(pcs) | DELIVERY MODE |
|---------------|--------------|-----------|----------------------|-------------------------|----------------------------|---------------|
| YJG85G06B | F1 | YJG85G06B | 5000 | 10000 | 100000 | 13" reel |

YJG85G06B



YJG85G06B

Typical Electrical and Thermal Characteristics Diagrams

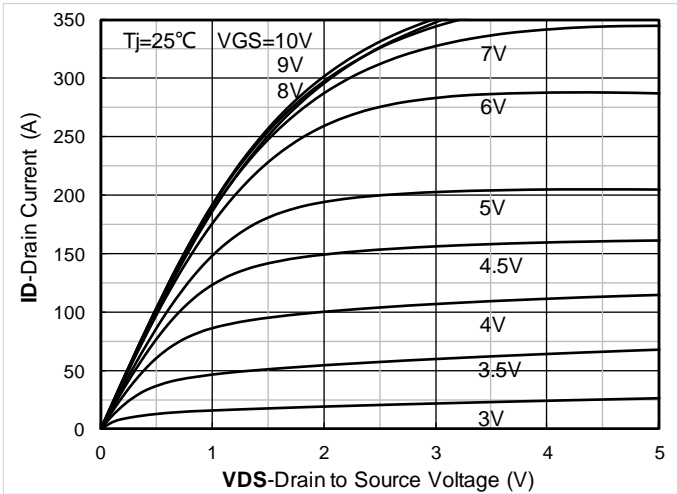


Figure 1. Output Characteristics

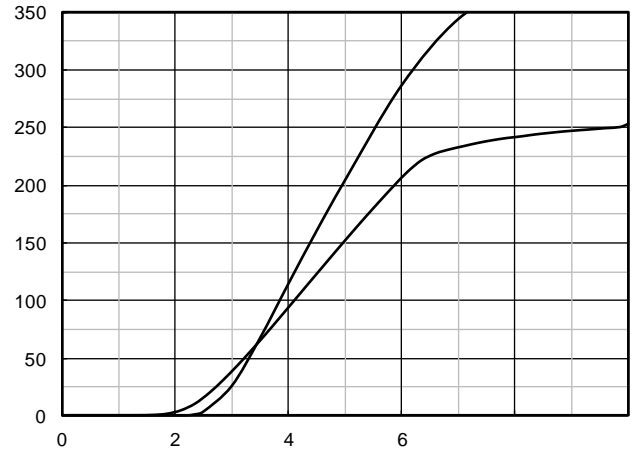


Figure 2. Transfer Characteristics

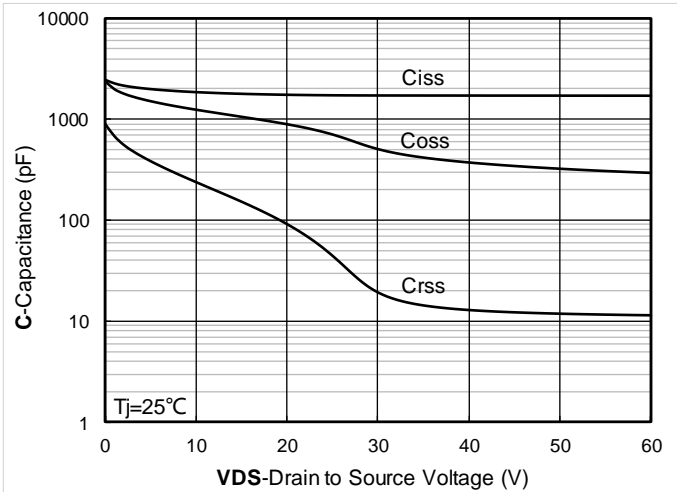


Figure 3. Capacitance Characteristics

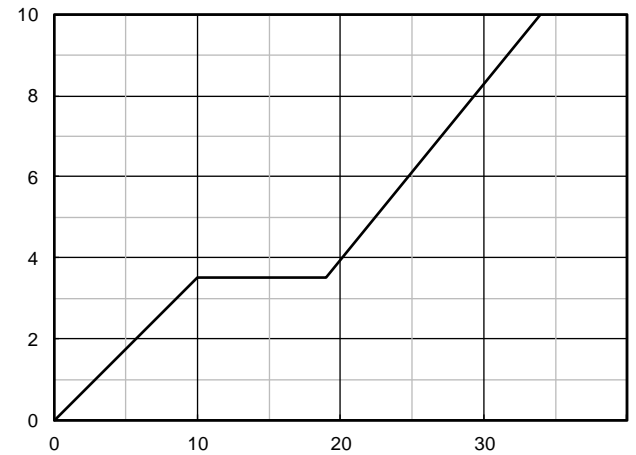


Figure 4. Gate Charge

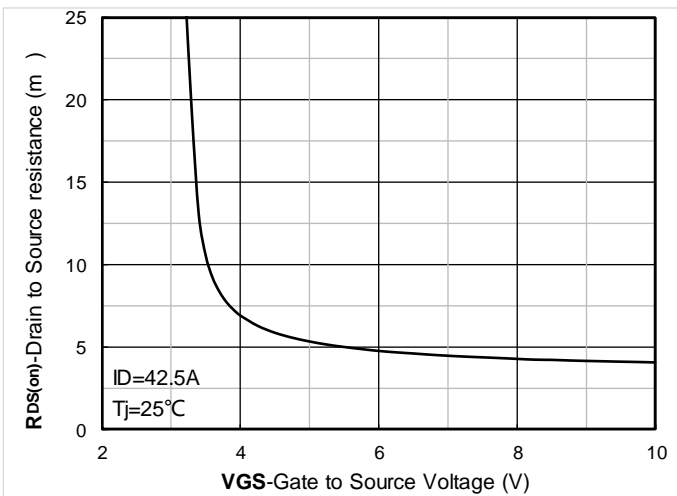


Figure 5. On-Resistance vs Gate to Source Voltage

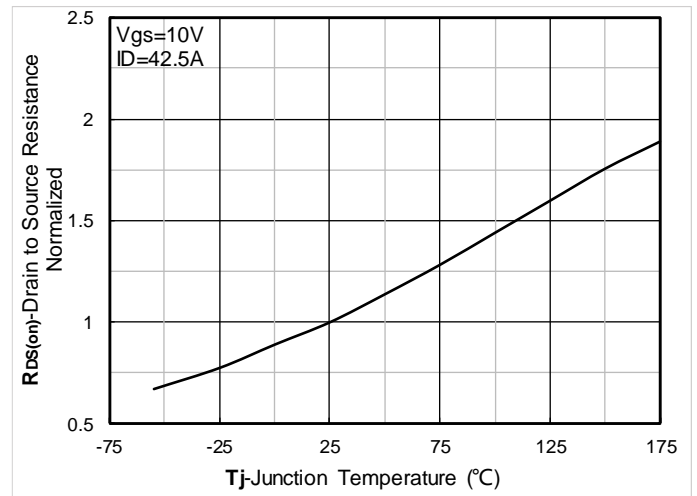


Figure 6. Normalized On-Resistance



YJG85G06B

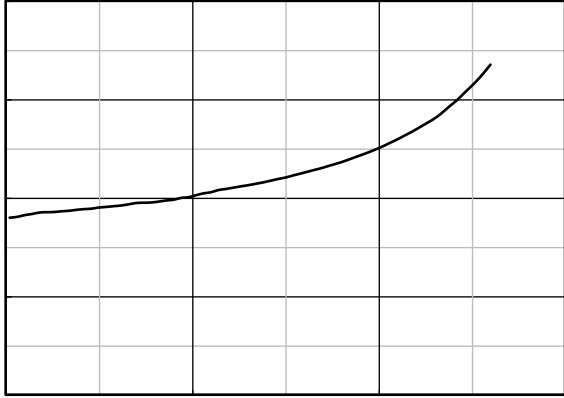


Figure 7. $R_{DS(on)}$ VS Drain Current

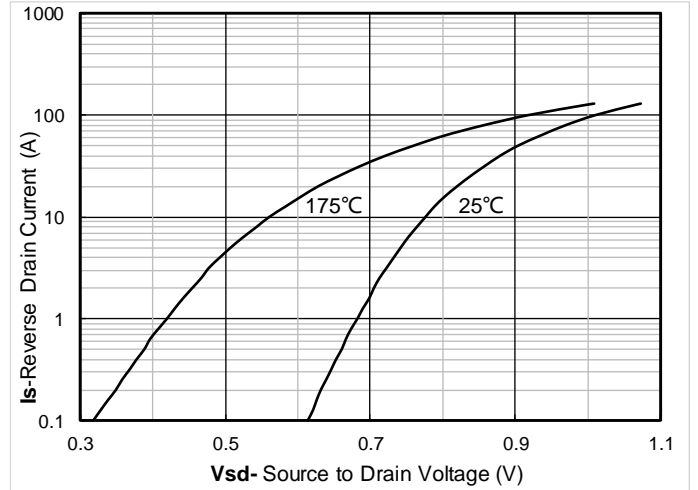


Figure 8. Forward characteristics of reverse diode

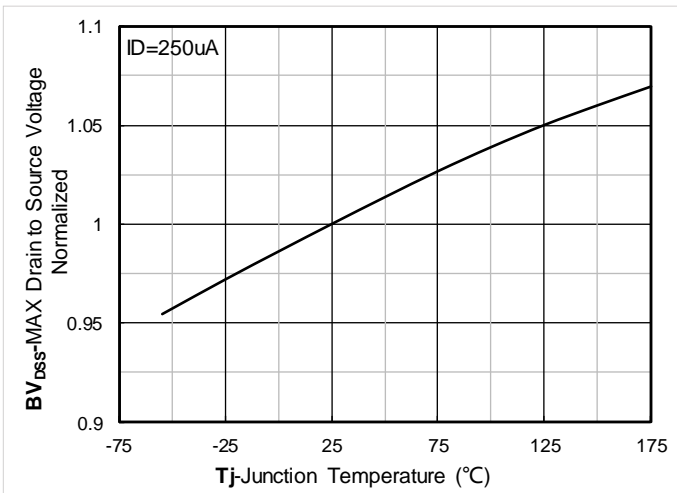


Figure 9. Normalized breakdown voltage

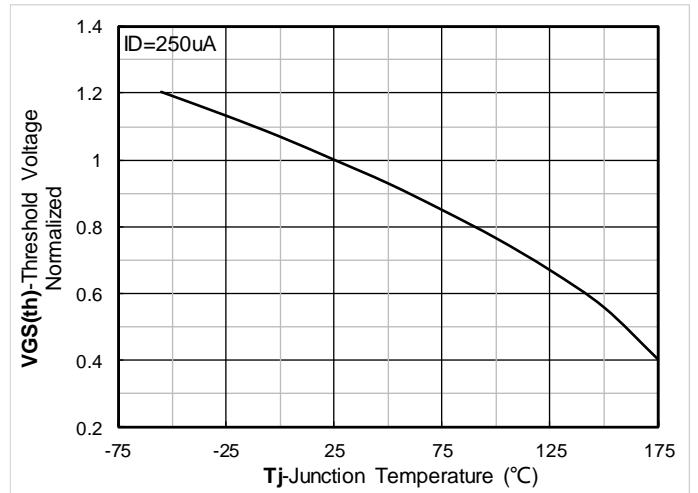


Figure 10. Normalized Threshold voltage

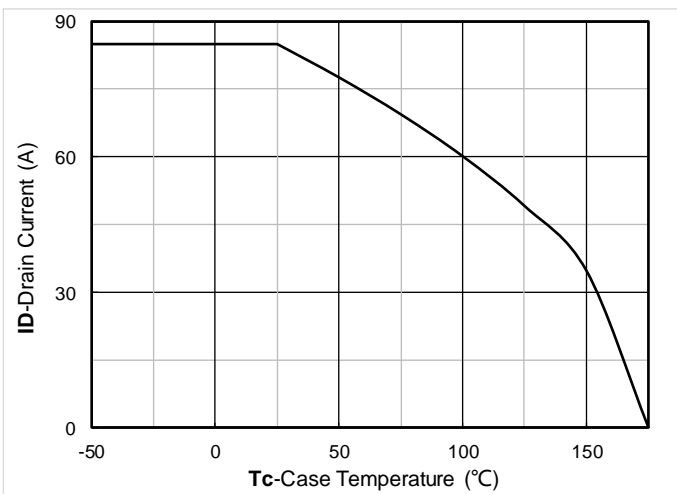


Figure 11. Current dissipation

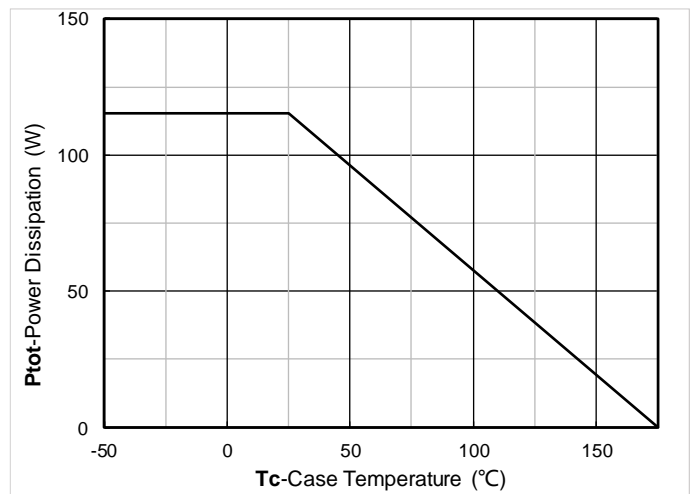


Figure 12. Power dissipation

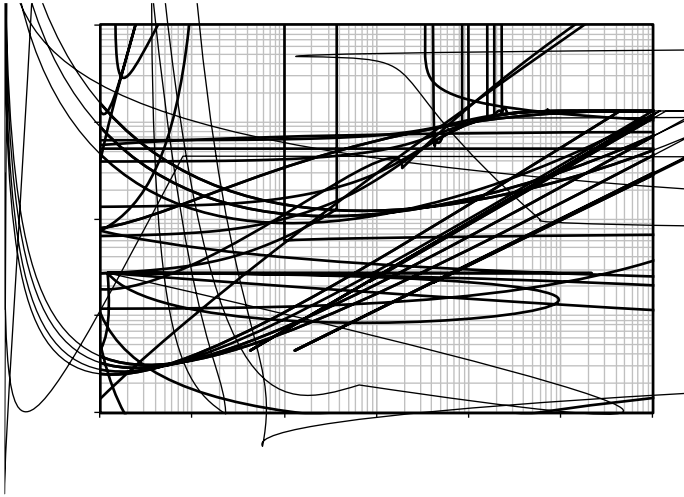


Figure 13. Maximum Transient Thermal Impedance

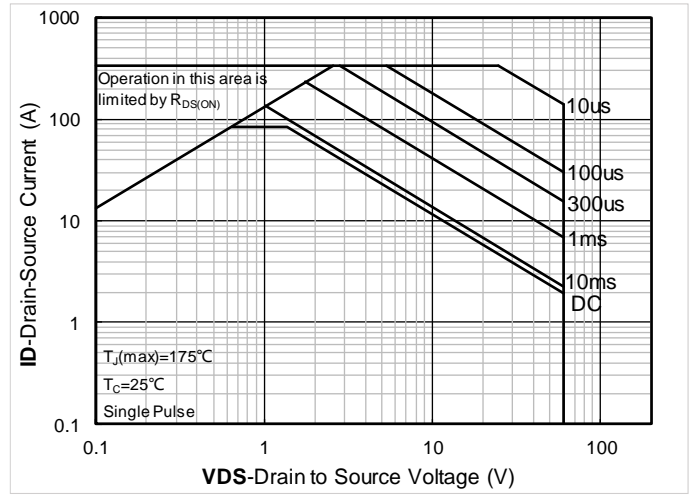


Figure 14. Safe Operation Area

Test Circuits & Waveforms

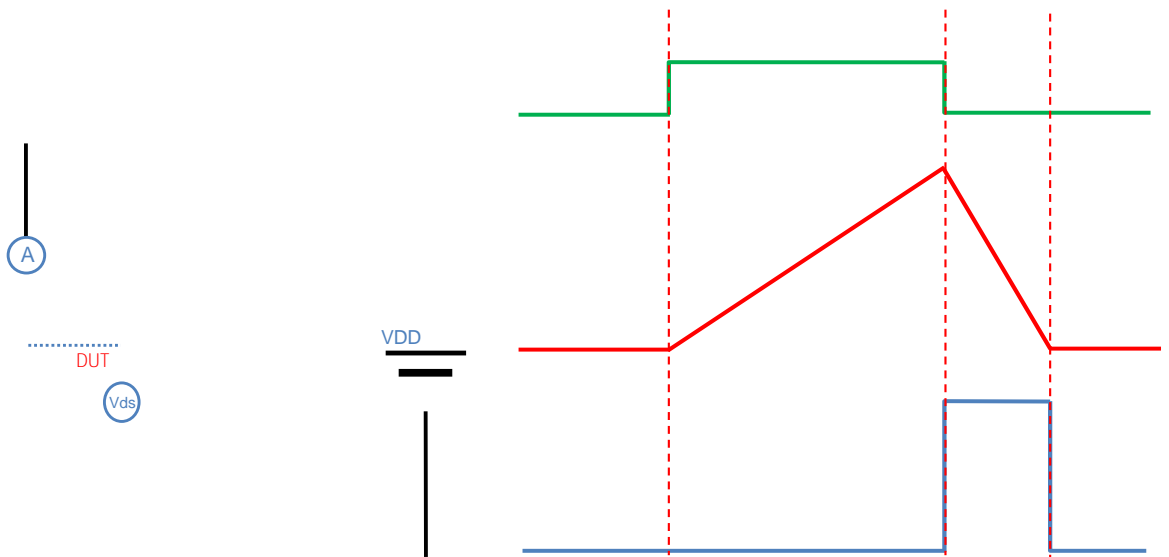


Figure A. Unclamped Inductive Switching (UIS) Test Circuit & Waveform

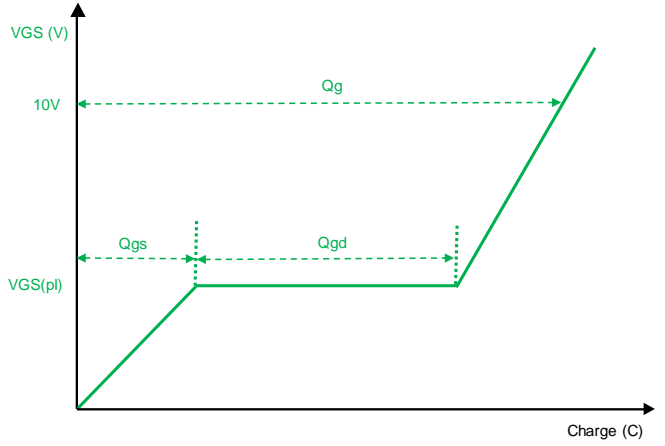
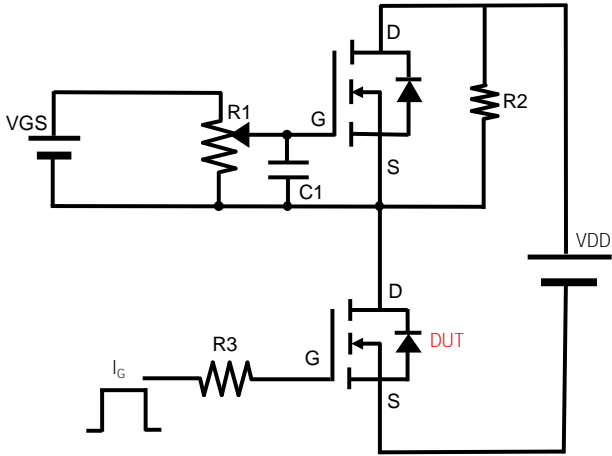


Figure B. Gate Charge Test Circuit & Waveform

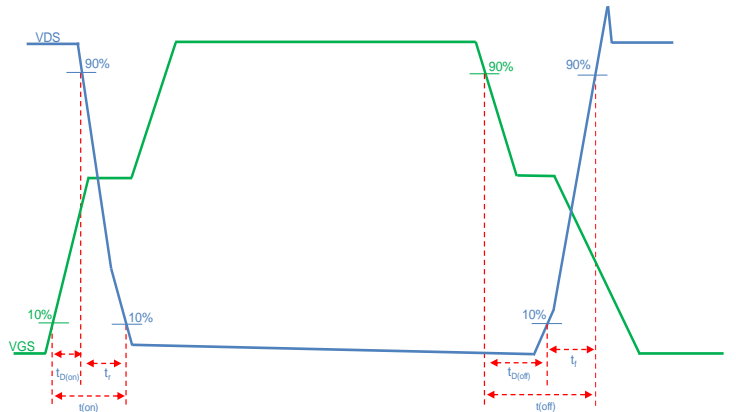
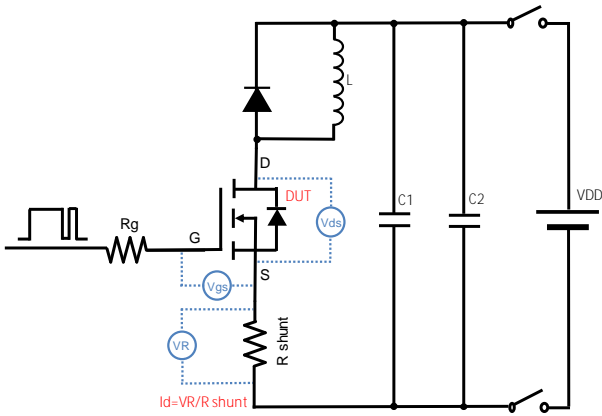


Figure C. Resistive Switching Test Circuit & Waveform

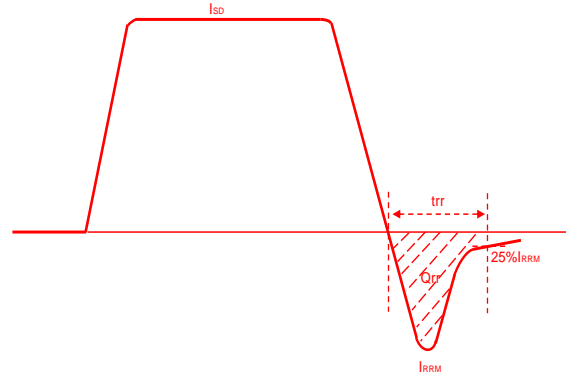
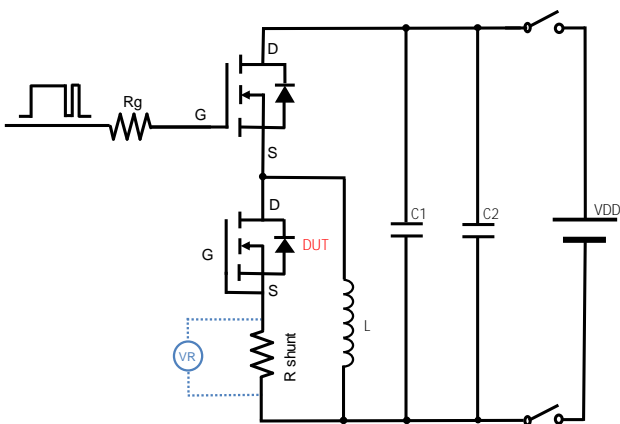
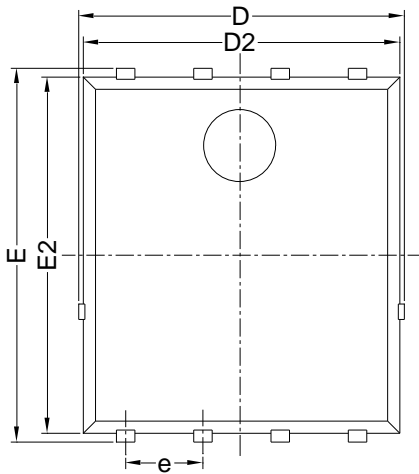


Figure D. Diode Recovery Test Circuit & Waveform

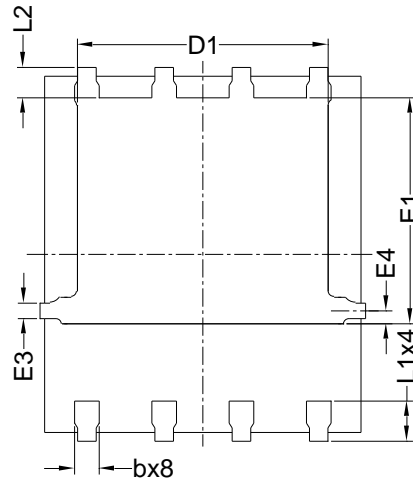


YJG85G06B

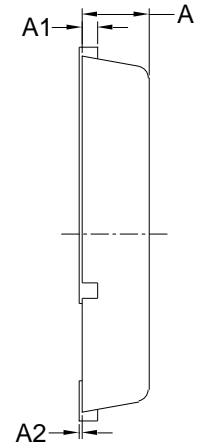
PDFN5060-8L-B-1.1MM Package information



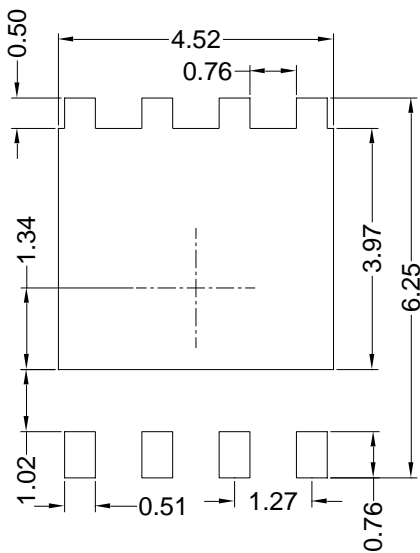
Top View



Bottom View



Side View



Suggested Solder Pad Layout
Top View

| SYMBOL | MILLIMETER | | |
|--------|------------|------|------|
| | MIN | NOM | MAX |
| D | 5.15 | 5.35 | 5.55 |
| E | 5.95 | 6.15 | 6.35 |
| A | 1.00 | 1.10 | 1.20 |
| A1 | 0.254 BSC | | |
| A2 | | | 0.10 |
| D1 | 3.92 | 4.12 | 4.32 |
| E1 | 3.52 | 3.72 | 3.92 |
| D2 | 5.00 | 5.20 | 5.40 |
| E2 | 5.66 | 5.86 | 6.06 |
| E3 | 0.254 REF | | |
| E4 | 0.21 REF | | |
| L1 | 0.56 | 0.66 | 0.76 |
| L2 | 0.50 BSC | | |
| b | 0.31 | 0.41 | 0.51 |
| e | 1.27 BSC | | |

Note:

1. Controlling dimension: in millimeters.
2. General tolerance: ± 0.10 mm.
3. The pad layout is for reference purposes only.



YJG85G06B

Disc-